

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YING-CHIH CHEN	08/13/2020
CHAO-MING LIN	08/13/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	FULLPOWER TEK CO., LTD.
<b>Street Address:</b>	NO. 248, GONG 5TH RD.
<b>Internal Address:</b>	LONGTAN DIST.
<b>City:</b>	TAOYUAN CITY
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	325
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15939570
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<b>NAME OF SUBMITTER:</b>	BENJAMIN J. HAUPTMAN
<b>SIGNATURE:</b>	/Benjamin J. Hauptman/
<b>DATE SIGNED:</b>	08/17/2020
<b>Total Attachments: 1</b>	
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ASSIGNMENT

WHEREAS I, Ying-Chih CHEN; Chao-Ming LIN, have made a certain new and useful invention as set forth in an application for United States Letters Patent, entitled PRINT CIRCUIT BOARD AND MANUFACTURING METHOD THEREOF, for which an application for United States Letters Patent was filed on March 29, 2018, and identified by United States Patent Application No. 15/939,570;

AND WHEREAS, FULLPOWER TEK CO., LTD., having a place of business at (hereafter "said assignee") No.248, Gong 5<sup>th</sup> Rd., Longtan Dist., Taoyuan City, Taiwan 325, is desirous of acquiring the entire right, title and interest in and to said invention and in and to any and all Letters Patent of the United States and foreign countries which may be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt for and sufficiency of which is hereby acknowledged, I do hereby sell, assign, transfer and set over unto said assignee, its legal representatives, successors, and assigns, the entire right, title and interest in and to said invention as set forth in the above-mentioned application, including any continuations, continuations-in-part, divisions, reissues, re-examinations or extensions thereof, and in and to any and all patents of the United States and foreign countries which may be issued for said invention;

UPON SAID CONSIDERATIONS, I hereby agree with the said assignee that I will not execute any writing or do any act whatsoever conflicting with these presents, and that I will, at any time upon request, without further or additional consideration but at the expense of said assignee, execute such additional assignments and other writings and do such additional acts as said assignee may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuations, continuations-in-part, reexamined, reissued, or extended Letters Patent of the United States or of any and all foreign countries on said invention, and in enforcing any rights or chooses in action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of the assigns and legal representatives of assignor and said assignee;

AND I request the Commissioner of Patents and Trademarks to issue any Letters Patent of the United States which may be issued for said invention to said assignee, its legal representatives, successors or assigns, as the sole owner of the entire right, title and interest in and to said patent and the invention covered thereby.

Aug. 13<sup>th</sup>, 2020  
Date

Ying-Chih Chen  
Ying-Chih CHEN

Aug. 13<sup>th</sup>, 2020  
Date

Chao-Ming Lin  
Chao-Ming LIN